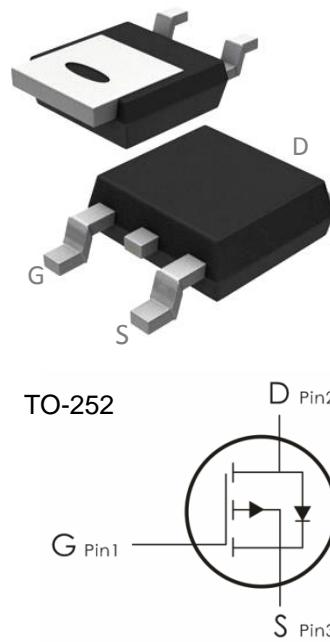


## P-Channel 60 V (D-S) MOSFET

### Description:

This P-Channel MOSFET uses advanced trench technology and design to provide excellent  $R_{DS(on)}$  with low gate charge. It can be used in a wide variety of applications.



### Features:

- 1)  $V_{DS}=-60V, I_D=-30A, R_{DS(on)}<35m\Omega @V_{GS}=-10V$
- 2) Low gate charge.
- 3) Green device available.
- 4) Advanced high cell density trench technology for ultra  $R_{DS(on)}$ .
- 5) Excellent package for good heat dissipation.

### Absolute Maximum Ratings: ( $T_c=25^\circ C$ unless otherwise noted)

Symbol	Parameter	Ratings	Units
$V_{DS}$	Drain-Source Voltage	-60	V
$V_{GS}$	Gate-Source Voltage	$\pm 20$	V
$I_D$	Continuous Drain Current	-30	A
	Continuous Drain Current- $T_C=100^\circ C$	-19	
	Pulsed Drain Current <sup>1</sup>	---	
$E_{AS}$	Single Pulse Avalanche Energy	225	mJ
$P_D$	Power Dissipation	50	W
$T_J, T_{STG}$	Operating and Storage Junction Temperature Range	-55 to +175	$^\circ C$

### Thermal Characteristics:

Symbol	Parameter	Max	Units
$R_{eJC}$	Thermal Resistance,Junction to Case	3	$^\circ C/W$
$R_{eJA}$	Thermal Resistance,Junction to Ambient	42	

Electrical Characteristics: ( $T_c=25^\circ\text{C}$  unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
<b>Off Characteristics</b>						
$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=250\ \mu\text{A}$	-60	---	---	V
$I_{\text{DSS}}$	Zero Gate Voltage Drain Current	$V_{\text{GS}}=0\text{V}, V_{\text{DS}}=-60\text{V}$	---	---	-1	$\mu\text{A}$
$I_{\text{GSS}}$	Gate-Source Leakage Current	$V_{\text{GS}}=\pm 20\text{V}, V_{\text{DS}}=0\text{A}$	---	---	$\pm 100$	nA
<b>On Characteristics</b>						
$V_{\text{GS}(\text{th})}$	GATE-Source Threshold Voltage	$V_{\text{GS}}=V_{\text{DS}}, I_{\text{D}}=250\ \mu\text{A}$	-1	-1.8	-2.5	V
$R_{\text{DS}(\text{ON})}$	Drain-Source On Resistance <sup>②</sup>	$V_{\text{GS}}=-10\text{V}, I_{\text{D}}=-15\text{A}$	---	26	35	$\text{m}\ \Omega$
		$V_{\text{GS}}=-4.5\text{V}, I_{\text{D}}=-10\text{A}$	---	32	40	
$G_{\text{FS}}$	Forward Transconductance	$V_{\text{DS}}=-10\text{V}, I_{\text{D}}=-15\text{A}$	---	---	---	S
<b>Dynamic Characteristics</b>						
$C_{\text{iss}}$	Input Capacitance	$V_{\text{DS}}=-30\text{V}, V_{\text{GS}}=0\text{V}, f=1\text{MHz}$	---	2535	---	$\text{pF}$
$C_{\text{oss}}$	Output Capacitance		---	130	---	
$C_{\text{rss}}$	Reverse Transfer Capacitance		---	75	---	
<b>Switching Characteristics</b>						
$t_{\text{d(on)}}$	Turn-On Delay Time	$V_{\text{DD}}=-30\text{V}, I_{\text{D}}=-10\text{A}, R_{\text{GEN}}=6.8\ \Omega, V_{\text{GS}}=-10\text{V}$	---	14	---	ns
$t_r$	Rise Time		---	18	---	ns
$t_{\text{d(off)}}$	Turn-Off Delay Time		---	42	---	ns
$t_f$	Fall Time		---	15	---	ns
$Q_g$	Total Gate Charge	$V_{\text{GS}}=-10\text{V}, V_{\text{DS}}=-30\text{V}, I_{\text{D}}=-10\text{A}$	---	46	---	nC
$Q_{\text{gs}}$	Gate-Source Charge		---	11	---	nC
$Q_{\text{gd}}$	Gate-Drain "Miller" Charge		---	10	---	nC
<b>Drain-Source Diode Characteristics</b>						
$V_{\text{SD}}$	Source-Drain Diode Forward Voltage	$V_{\text{GS}}=0\text{V}, I_{\text{S}}=-15\text{A}, T_j=25^\circ\text{C}$	---	-0.88	-1.2	V

$t_{rr}$	Reverse Recovery Time	$I_{sd}=-20A, V_{GS}=0V$	---	28	---	ns
$Q_{rr}$	Reverse Recovery Charge		$.dI/dt=-500A/\mu s$	---	165	---

## Notes:

1. Repetitive rating; pulse width limited by max. junction temperature.
2. Pulse width  $\leq 300 \mu s$ ; duty cycle  $\leq 2\%$ .
3. Limited by  $T_{Jmax}$ , starting  $T_J = 25 \mu A C$ ,  $L = 0.5mH$ ,  $R_G = 25 \Omega$ ,  $I_{AS} = -32A$ ,  $V_{GS} = -10V$ . Part not recommended for use above this value

Typical Characteristics: ( $T_C=25^\circ C$  unless otherwise noted)

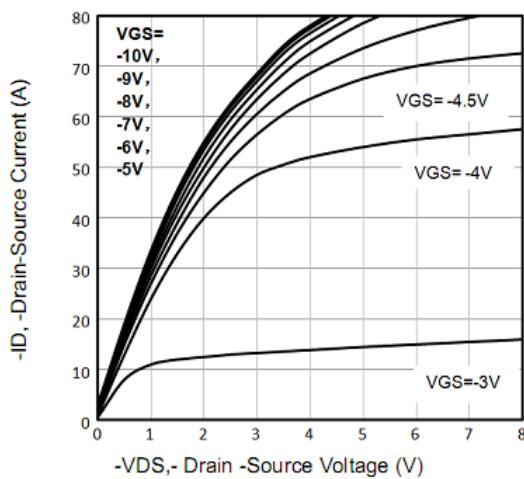


Fig1. Typical Output Characteristics

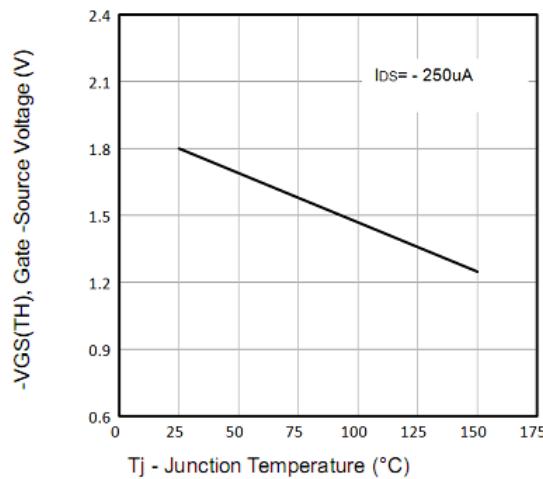


Fig2.  $-VGS(TH)$  Gate-Source Voltage Vs.  $T_J$

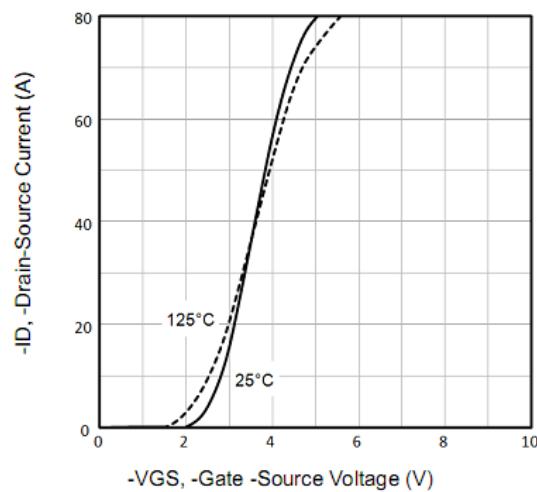


Fig3. Typical Transfer Characteristics

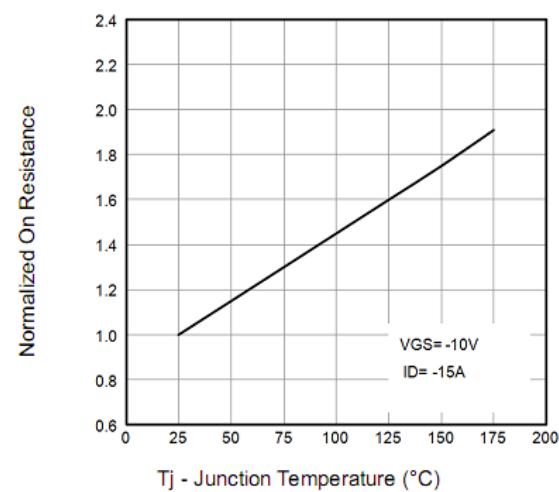


Fig4. Normalized On-Resistance Vs.  $T_J$

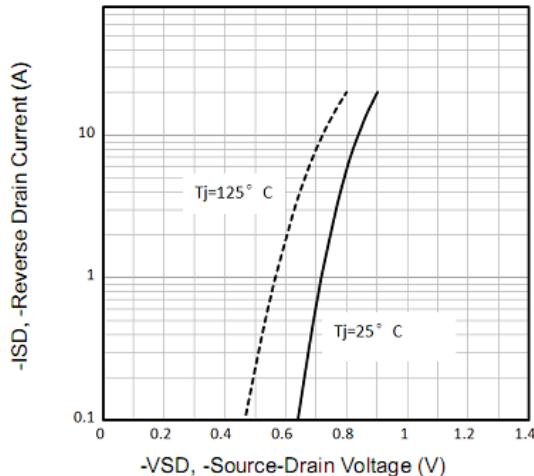


Fig 5. Typical Source-Drain Diode Forward Voltage

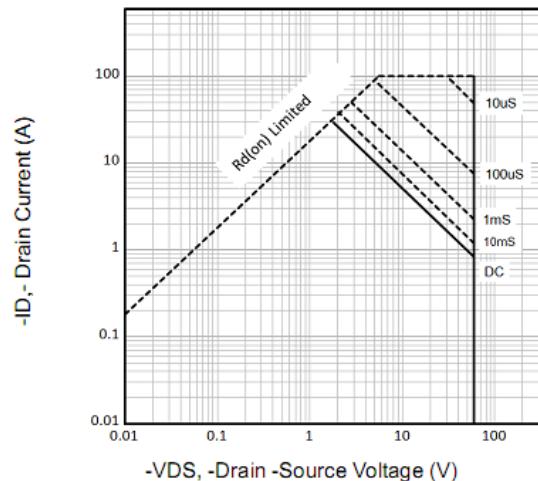


Fig 6. Maximum Safe Operating Area

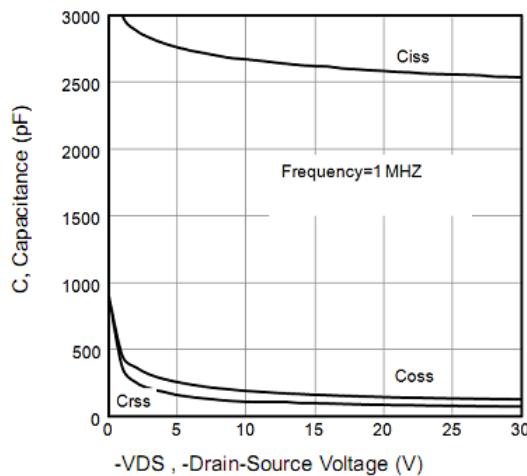


Fig 7. Typical Capacitance Vs. Drain-Source Voltage

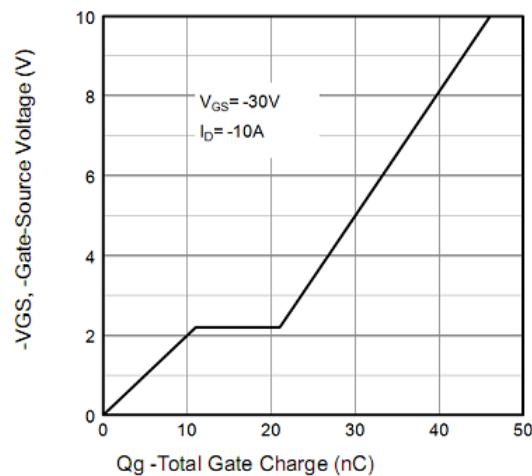


Fig 8. Typical Gate Charge Vs. Gate-Source Voltage

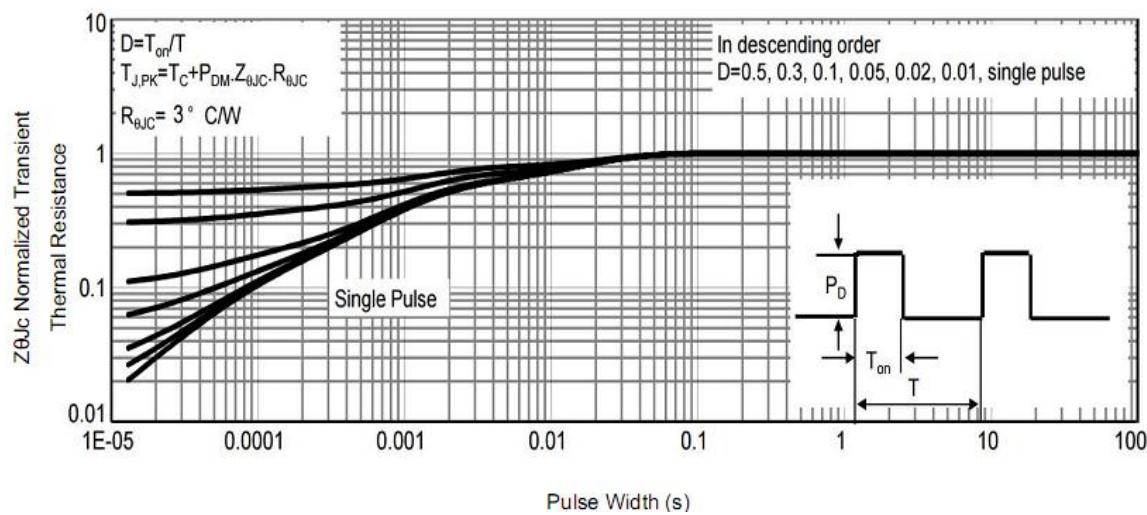


Fig 9. Normalized Maximum Transient Thermal Impedance

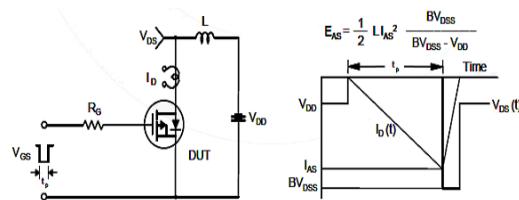


Fig10. Unclamped Inductive Test Circuit and Waveforms

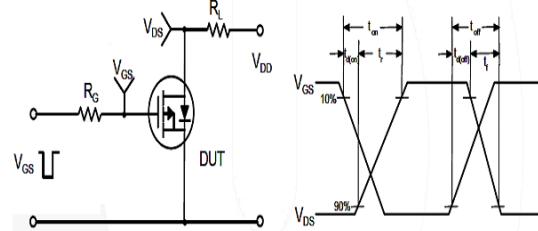
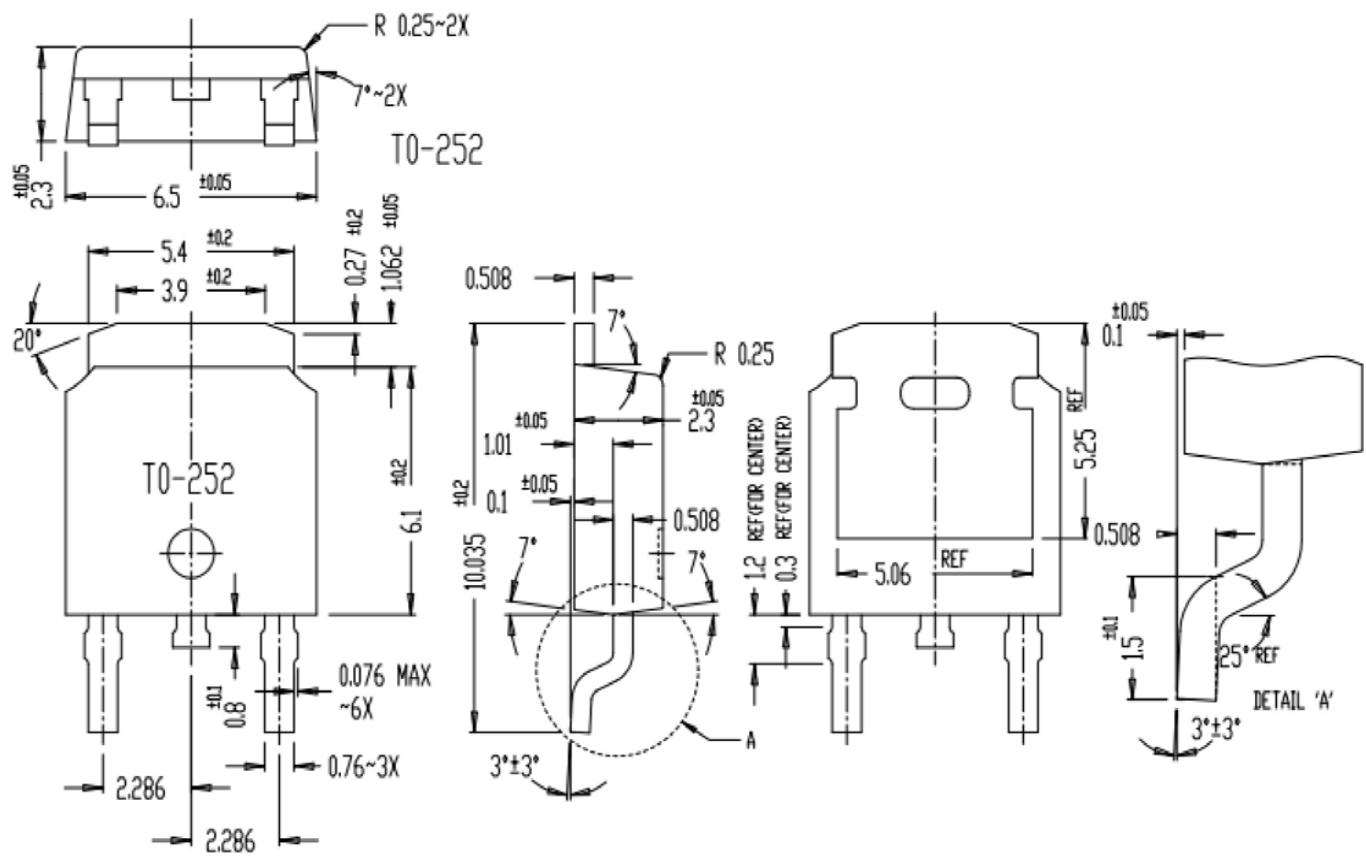


Fig11. Switching Time Test Circuit and waveforms

## 外形尺寸图 / Package Dimensions



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[IPS70R2K0CEAKMA1](#) [BSF024N03LT3 G](#) [PSMN4R2-30MLD](#) [TK31J60W5,S1VQ\(O](#) [2SK2614\(TE16L1,Q\)](#) [DMN1017UCP3-7](#)  
[EFC2J004NUZTDG](#) [FCAB21350L1](#) [P85W28HP2F-7071](#) [DMN1053UCP4-7](#) [NTE2384](#) [NTE2969](#) [NTE6400A](#) [DMC2700UDMQ-7](#)  
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[C3M0021120D](#) [DMN6022SSD-13](#)